

## **BSR50**

## **NPN Darlington Transistor**

- This device designed for applications requiring extremely high gain at collector currents to 0.5A.
- · Sourced from Process 06.



### 1. Emitter 2. Collector 3. Base

## **NPN Epitaxial Silicon Transistor**

## **Absolute Maximum Ratings** $T_A$ =25°C unless otherwise noted

Symbol	Parameter	Ratings	Units	
V <sub>CEO</sub>	Collector-Emitter Voltage	45	V	
V <sub>CBO</sub>	Collector-Base Voltage	60	V	
V <sub>EBO</sub>	Emitter-Base Voltage	5	V	
I <sub>C</sub>	Collector Current	1.5	Α	
T <sub>J</sub> , T <sub>STG</sub>	Storage Temperature	-55 ~ 150	°C	

## **Electrical Characteristics** $T_A=25$ °C unless otherwise noted

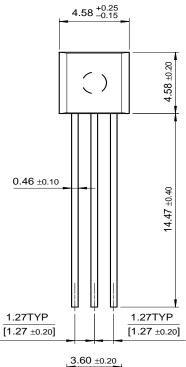
Symbol	Parameter	Test Condition	Min.	Тур.	Max.	Units
BV <sub>CEO</sub>	Collector-Emitter Breakdown Voltage *	$I_C = 10 \text{mA}, I_B = 0$	45			V
BV <sub>CBO</sub>	Collector-Base Breakdown Voltage	$I_C = 100 \mu A, I_B = 0$	60			V
BV <sub>EBO</sub>	Emitter-Base Breakdown Voltage	$I_E = 100 \mu A, I_C = 0$	5			V
I <sub>CBO</sub>	Collector Cut-off Current	$V_{CB} = 45V, I_{E} = 0$			50	nA
I <sub>EBO</sub>	Emitter Cut-off Current	$V_{EB} = 4.0V, I_{C} = 0$			50	nA
h <sub>FE</sub>	DC Current Gain	V <sub>CE</sub> = 10V, I <sub>C</sub> = 150mA V <sub>CE</sub> = 10V, I <sub>C</sub> = 0.5A	1,000 2,000			
V <sub>CE</sub> (sat)	Collector-Emitter Saturation Voltage	$I_C = 500 \text{mA}, I_B = 500 \mu \text{A}$			1.3	V
\/ (aat)	Page Emitter Ceturation Voltage	I <sub>C</sub> = 1.0A, I <sub>B</sub> = 4.0mA			1.6	V
V <sub>BE</sub> (sat)	Base-Emitter Saturation Voltage	$I_C = 500 \text{mA}, I_B = 500 \mu \text{A}$ $I_C = 1.0 \text{mA}, I_B = 4.0 \text{mA}$			0.9 2.2	V

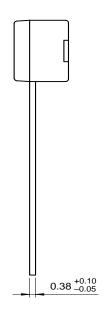
## Thermal Characteristics $T_A=25$ °C unless otherwise noted

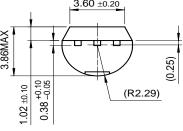
Symbol	Parameter	Max.	Units
P <sub>D</sub>	Total Device Dissipation	625	mW
	Derate above 25°C	5.0	mW/°C
$R_{\theta JC}$	Thermal Resistance, Junction to Case		°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient 200 °C		°C/W

# **Package Dimensions**

TO-92







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